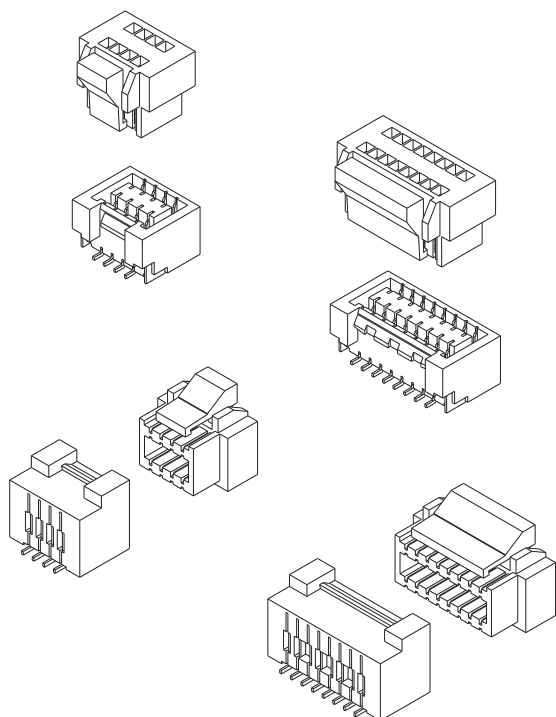




技术特性/Specifications:

额定电压 Rated voltage: 50V AC, DC
额定电流 Rated current: 1.25A AC, DC
接触电阻 Contact resistance: 50m Ω max
绝缘电阻 Insulation resistance: 100M Ω min
耐压 Withstand voltage: 500V AC/minute
环境温度 Ambient temperature: -40 $^{\circ}$ C~+105 $^{\circ}$ C
适用线规 Wire range: AWG#32~#28

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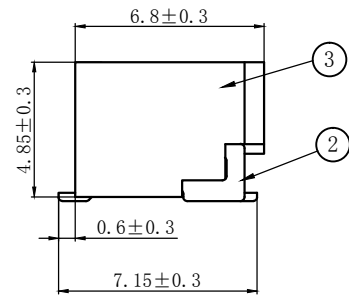
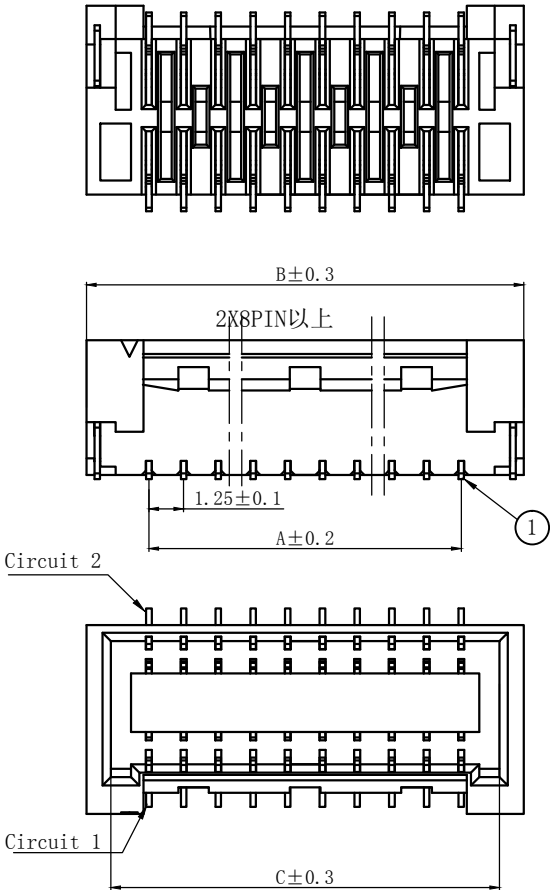
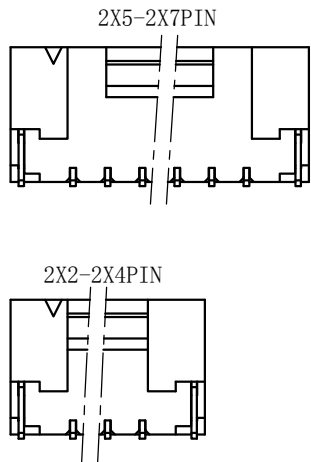
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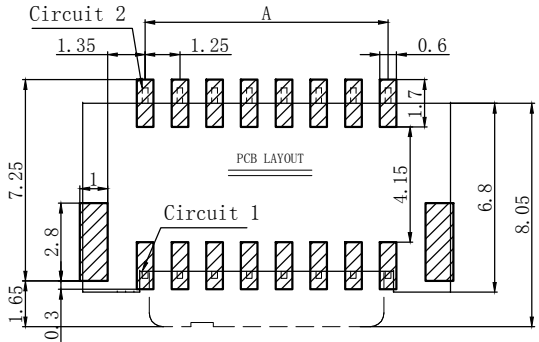
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REV.		REVISION DESCRIPTION				DATE	APPD



技术特性/Specifications:
额定电压Rated voltage : 50V AC.DC.
额定电流Rated current : 1.25A AC.DC.
接触电阻Contact resistance: 50mΩ MAX
绝缘电阻Insulation resistance: 100 MΩ MIN
耐压Withstand voltage: 500V AC/minute
环境温度Ambient temperature: -40℃~+105℃
针座Wafer:LCP UL94V-0

3	③	基座	LCP	1	UL94V-0
2	②	焊片	黄铜	2	镀锡
1	①	接触件	磷青铜	N	镀锡
序号	图号	名称	材料	数量	附件

Circuits	Product name	Dimension mm			Circuits	Product name	Dimension mm		
		A	B	C			A	B	C
2X2	GHD-4AB	1.25	5.75	4.00	2X12	GHD-24AB	13.75	18.25	16.50
2X3	GHD-6AB	2.50	7.00	5.25	2X13	GHD-26AB	15.00	19.50	17.75
2X4	GHD-8AB	3.75	8.25	6.50	2X14	GHD-28AB	16.25	20.75	19.00
2X5	GHD-10AB	5.00	9.50	7.75	2X15	GHD-30AB	17.50	22.00	20.25
2X6	GHD-12AB	6.25	10.75	9.00	2X16	GHD-32AB	18.75	23.25	21.50
2X7	GHD-14AB	7.50	12.00	10.25	2X17	GHD-34AB	20.00	24.50	22.75
2X8	GHD-16AB	8.75	13.25	11.50	2X18	GHD-36AB	21.25	25.75	24.00
2X9	GHD-18AB	10.00	14.50	12.75	2X19	GHD-38AB	22.50	27.00	25.25
2X10	GHD-20AB	11.25	15.75	14.00	2X20	GHD-40AB	23.75	28.25	26.50
2X11	GHD-22AB	12.50	17.00	15.25					



GENERAL TOLERANCES (UNLESS SPECIFIED)		ZHE JIANG DELI CONNECTORS CO.,LTD	
.X: ± 0.25	X° : ± 3.0°	PRODUCT NAME: DL12512 (GHD)-AB	TITLE: 1.25 mm Pitch Wire To Board Wafer
.XX: ± 0.15	.X° : ± 2.0°	DR:Chen QuanLong	DATE:22/11/30
.XXX: ± 0.01	.XX° : ± 1.0°	CHKD:Wu Hui	DATE:22/11/30
FINISH:		APPD:Ren AnDe	DATE:22/11/30
DRAWING NO:			

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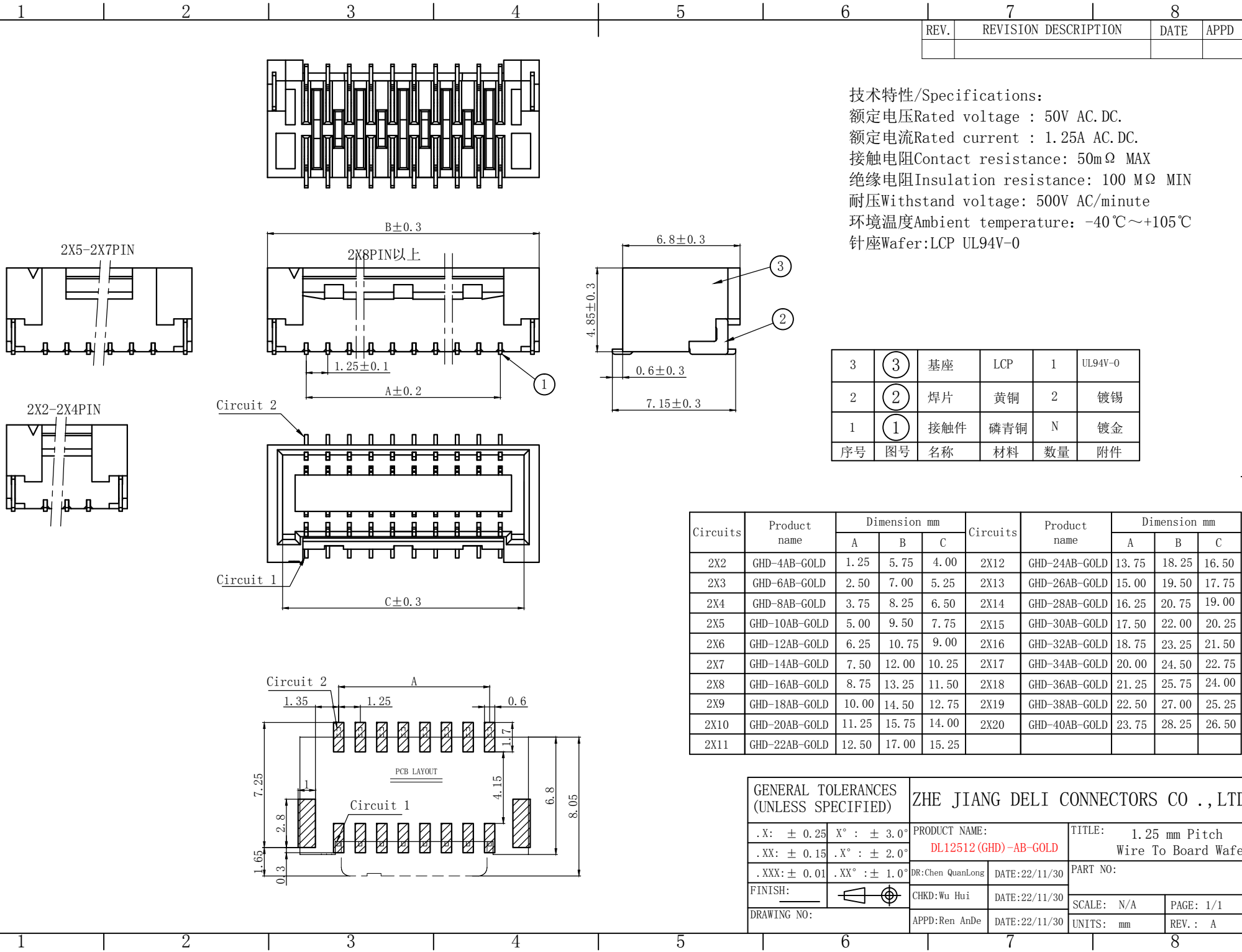
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技术特性/Specifications:
额定电压Rated voltage : 50V AC.DC.
额定电流Rated current : 1.25A AC.DC.
接触电阻Contact resistance: 50mΩ MAX
绝缘电阻Insulation resistance: 100 MΩ MIN
耐压Withstand voltage: 500V AC/minute
环境温度Ambient temperature: -40℃~+105℃
针座Wafer:LCP UL94V-0

3	③	基座	LCP	1	UL94V-0
2	②	焊片	黄铜	2	镀锡
1	①	接触件	磷青铜	N	镀金
序号	图号	名称	材料	数量	附件

Circuits	Product name	Dimension mm			Circuits	Product name	Dimension mm		
		A	B	C			A	B	C
2X2	GHD-4AB-GOLD	1.25	5.75	4.00	2X12	GHD-24AB-GOLD	13.75	18.25	16.50
2X3	GHD-6AB-GOLD	2.50	7.00	5.25	2X13	GHD-26AB-GOLD	15.00	19.50	17.75
2X4	GHD-8AB-GOLD	3.75	8.25	6.50	2X14	GHD-28AB-GOLD	16.25	20.75	19.00
2X5	GHD-10AB-GOLD	5.00	9.50	7.75	2X15	GHD-30AB-GOLD	17.50	22.00	20.25
2X6	GHD-12AB-GOLD	6.25	10.75	9.00	2X16	GHD-32AB-GOLD	18.75	23.25	21.50
2X7	GHD-14AB-GOLD	7.50	12.00	10.25	2X17	GHD-34AB-GOLD	20.00	24.50	22.75
2X8	GHD-16AB-GOLD	8.75	13.25	11.50	2X18	GHD-36AB-GOLD	21.25	25.75	24.00
2X9	GHD-18AB-GOLD	10.00	14.50	12.75	2X19	GHD-38AB-GOLD	22.50	27.00	25.25
2X10	GHD-20AB-GOLD	11.25	15.75	14.00	2X20	GHD-40AB-GOLD	23.75	28.25	26.50
2X11	GHD-22AB-GOLD	12.50	17.00	15.25					

GENERAL TOLERANCES (UNLESS SPECIFIED)		ZHE JIANG DELI CONNECTORS CO.,LTD			
.X: ± 0.25	X°: ± 3.0°	PRODUCT NAME: DL12512 (GHD)-AB-GOLD		TITLE: 1.25 mm Pitch Wire To Board Wafer	
.XX: ± 0.15	.X°: ± 2.0°	DR:Chen QuanLong	DATE:22/11/30	PART NO:	
.XXX: ± 0.01	.XX°: ± 1.0°			SCALE: N/A	
FINISH:		CHKD:Wu Hui	DATE:22/11/30	PAGE: 1/1	
DRAWING NO:		APPD:Ren AnDe	DATE:22/11/30	UNITS: mm	REV.: A

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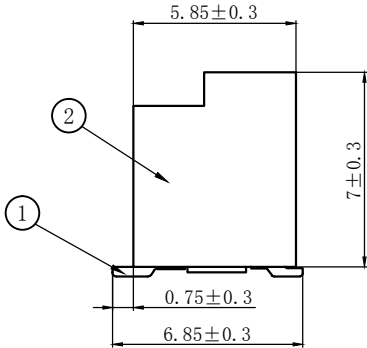
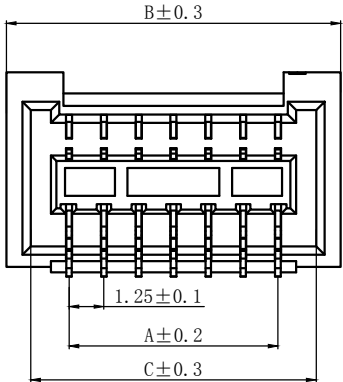
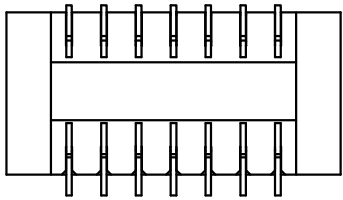
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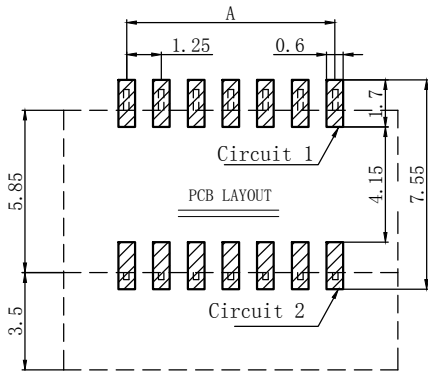
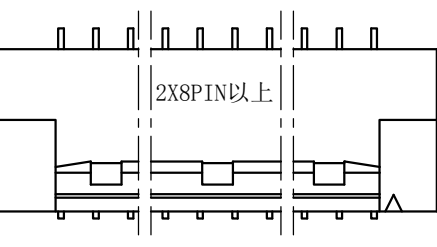
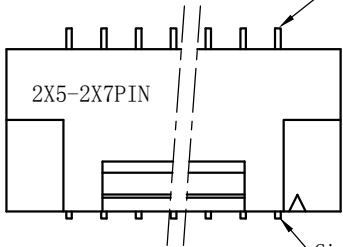
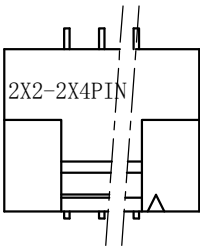
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REV.	REVISION DESCRIPTION	DATE	APPD



技术特性/Specifications:
额定电压Rated voltage : 50V AC.DC.
额定电流Rated current : 1.25A AC.DC.
接触电阻Contact resistance: 50mΩ MAX
绝缘电阻Insulation resistance: 100 MΩ MIN
耐压Withstand voltage: 500V AC/minute
环境温度Ambient temperature: -40℃~+105℃
针座Wafer:LCP UL94V-0

2	②	基座	LCP	1	UL94V-0
1	①	接触件	磷青铜	N	镀锡
序号	图号	名称	材料	数量	附件



Circuits	Product name	Dimension mm			Circuits	Product name	Dimension mm		
		A	B	C			A	B	C
2X2	GHD-4AWB	1.25	5.75	4.00	2X12	GHD-24AWB	13.75	18.25	16.50
2X3	GHD-6AWB	2.50	7.00	5.25	2X13	GHD-26AWB	15.00	19.50	17.75
2X4	GHD-8AWB	3.75	8.25	6.50	2X14	GHD-28AWB	16.25	20.75	19.00
2X5	GHD-10AWB	5.00	9.50	7.75	2X15	GHD-30AWB	17.50	22.00	20.25
2X6	GHD-12AWB	6.25	10.75	9.00	2X16	GHD-32AWB	18.75	23.25	21.50
2X7	GHD-14AWB	7.50	12.00	10.25	2X17	GHD-34AWB	20.00	24.50	22.75
2X8	GHD-16AWB	8.75	13.25	11.50	2X18	GHD-36AWB	21.25	25.75	24.00
2X9	GHD-18AWB	10.00	14.50	12.75	2X19	GHD-38AWB	22.50	27.00	25.25
2X10	GHD-20AWB	11.25	15.75	14.00	2X20	GHD-40AWB	23.75	28.25	26.50
2X11	GHD-22AWB	12.50	17.00	15.25					

GENERAL TOLERANCES (UNLESS SPECIFIED)		ZHE JIANG DELI CONNECTORS CO.,LTD			
.X: ± 0.25	X° : ± 3.0°	PRODUCT NAME: DL12512 (GHD)-AWB		TITLE: 1.25 mm Pitch Wire To Board Wafer	
.XX: ± 0.15	.X° : ± 2.0°	DR:Chen QuanLong	DATE:22/11/30	PART NO:	
.XXX: ± 0.01	.XX° : ± 1.0°			SCALE: N/A	
FINISH:		CHKD:Wu Hui	DATE:22/11/30	PAGE: 1/1	
DRAWING NO:		APPD:Ren AnDe	DATE:22/11/30	UNITS: mm	REV.: A

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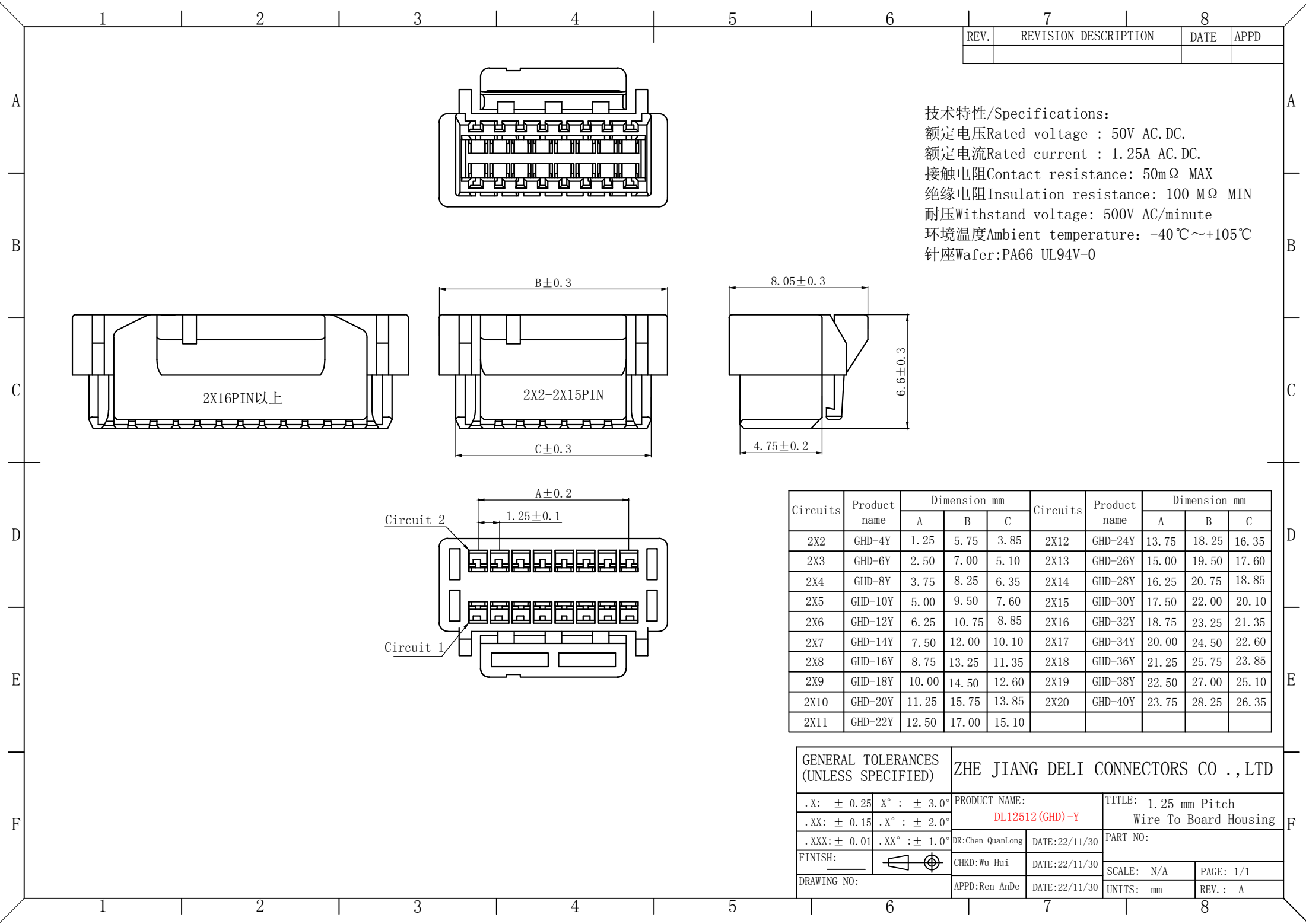
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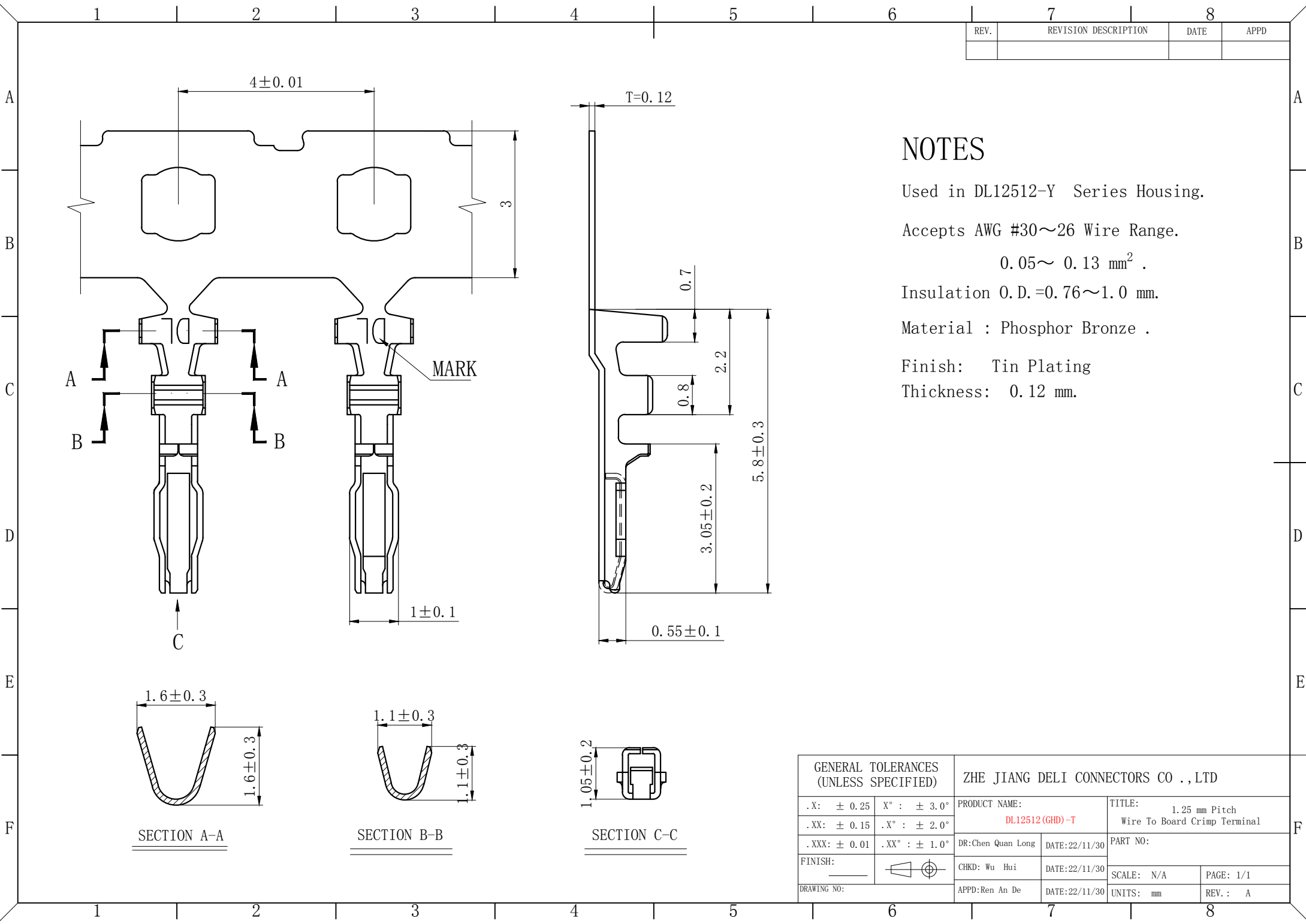


REV.	REVISION DESCRIPTION	DATE	APPD

技术特性/Specifications:
额定电压Rated voltage : 50V AC.DC.
额定电流Rated current : 1.25A AC.DC.
接触电阻Contact resistance: 50mΩ MAX
绝缘电阻Insulation resistance: 100 MΩ MIN
耐压Withstand voltage: 500V AC/minute
环境温度Ambient temperature: -40℃~+105℃
针座Wafer:PA66 UL94V-0

Circuits	Product name	Dimension mm			Circuits	Product name	Dimension mm		
		A	B	C			A	B	C
2X2	GHD-4Y	1.25	5.75	3.85	2X12	GHD-24Y	13.75	18.25	16.35
2X3	GHD-6Y	2.50	7.00	5.10	2X13	GHD-26Y	15.00	19.50	17.60
2X4	GHD-8Y	3.75	8.25	6.35	2X14	GHD-28Y	16.25	20.75	18.85
2X5	GHD-10Y	5.00	9.50	7.60	2X15	GHD-30Y	17.50	22.00	20.10
2X6	GHD-12Y	6.25	10.75	8.85	2X16	GHD-32Y	18.75	23.25	21.35
2X7	GHD-14Y	7.50	12.00	10.10	2X17	GHD-34Y	20.00	24.50	22.60
2X8	GHD-16Y	8.75	13.25	11.35	2X18	GHD-36Y	21.25	25.75	23.85
2X9	GHD-18Y	10.00	14.50	12.60	2X19	GHD-38Y	22.50	27.00	25.10
2X10	GHD-20Y	11.25	15.75	13.85	2X20	GHD-40Y	23.75	28.25	26.35
2X11	GHD-22Y	12.50	17.00	15.10					

GENERAL TOLERANCES (UNLESS SPECIFIED)				ZHE JIANG DELI CONNECTORS CO.,LTD			
.X: ± 0.25	.X°: ± 3.0°	PRODUCT NAME:		TITLE: 1.25 mm Pitch			
.XX: ± 0.15	.X°: ± 2.0°	DL12512 (GHD)-Y		Wire To Board Housing			
.XXX: ± 0.01	.XX°: ± 1.0°	DR:Chen QuanLong	DATE:22/11/30	PART NO:			
FINISH:		CHKD:Wu Hui	DATE:22/11/30	SCALE: N/A		PAGE: 1/1	
DRAWING NO:		APPD:Ren AnDe	DATE:22/11/30	UNITS: mm		REV.: A	



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NOTES

Used in DL12512-Y Series Housing.

Accepts AWG #30~26 Wire Range.

0.05~ 0.13 mm² .

Insulation O.D.=0.76~1.0 mm.

Material : Phosphor Bronze .

Finish: Tin Plating

Thickness: 0.12 mm.

GENERAL TOLERANCES (UNLESS SPECIFIED)				ZHE JIANG DELI CONNECTORS CO.,LTD			
.X: ± 0.25	X° : ± 3.0°	PRODUCT NAME:		TITLE: 1.25 mm Pitch Wire To Board Crimp Terminal			
.XX: ± 0.15	.X° : ± 2.0°	DL12512 (GHD)-T		PART NO:			
.XXX: ± 0.01	.XX° : ± 1.0°	DR:Chen Quan Long	DATE:22/11/30	SCALE: N/A			
FINISH:		CHKD: Wu Hui	DATE:22/11/30	PAGE: 1/1		UNITS: mm	
DRAWING NO:		APPD:Ren An De	DATE:22/11/30	REV. : A			

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